

Electronic Acknowledgement Receipt

EFS ID:	2181868
Application Number:	10525996
International Application Number:	
Confirmation Number:	6221
Title of Invention:	Protective structure of semiconductor wafer, method for protecting semiconductor wafer, multilayer protective sheet used therein, and method for processing semiconductor wafer
First Named Inventor/Applicant Name:	Hideo Senoo
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Extension of Time	EXTTime.pdf	132443	no	1
			7d3ea8affb42baa7907dd6ef3dd8b9f5a b022f94		
Warnings:					
Information:					
2	Amendment After Final	FOARespn.pdf	370716	no	4
			70477fa94a04c03823a96b561bdf7232 465a8494		
Warnings:					
Information:					
3	Translation of Foreign Priority Documents	DECTTRANS.pdf	3887289	no	54
			f1eba3a948b8e5b30cddce5a90c8194c 4fce93ef		
Warnings:					
Information:					
4	Fee Worksheet (PTO-06)	fee-info.pdf	8236	no	2
			72907c2000afe694ad3109ac2b76522e 27d34e0f		
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Total Files Size (in bytes):			4398684		

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.